## 阅读申明

- 1.本站收集的数据手册和产品资料都来自互联网,版权归原作者所有。如读者和版权方有任何异议请及时告之,我们将妥善解决。
- 2.本站提供的中文数据手册是英文数据手册的中文翻译,其目的是协助用户阅读,该译文无法自动跟随原稿更新,同时也可能存在翻译上的不当。建议读者以英文原稿为参考以便获得更精准的信息。
- 3.本站提供的产品资料,来自厂商的技术支持或者使用者的心得体会等,其内容可能存在描 叙上的差异,建议读者做出适当判断。
- 4.如需与我们联系,请发邮件到marketing@iczoom.com,主题请标有"数据手册"字样。

# **Read Statement**

- 1. The datasheets and other product information on the site are all from network reference or other public materials, and the copyright belongs to the original author and original published source. If readers and copyright owners have any objections, please contact us and we will deal with it in a timely manner.
- 2. The Chinese datasheets provided on the website is a Chinese translation of the English datasheets. Its purpose is for reader's learning exchange only and do not involve commercial purposes. The translation cannot be automatically updated with the original manuscript, and there may also be improper translations. Readers are advised to use the English manuscript as a reference for more accurate information.
- 3. All product information provided on the website refer to solutions from manufacturers' technical support or users the contents may have differences in description, and readers are advised to take the original article as the standard.
- 4. If you have any questions, please contact us at marketing@iczoom.com and mark the subject with "Datasheets" .

# Four-quadrant triac, enhanced noise immunity Rev. 01 — 19 May 2008

**Product data sheet** 

## 1. Product profile

#### 1.1 General description

Passivated sensitive gate triac in a SOT54A (wide pitch) plastic package

#### 1.2 Features

- Sensitive gate
- Direct interfacing to logic level ICs
- Enhanced immunity to voltage transients and noise
- Gate triggering in four quadrants
- Direct interfacing to low power gate drive circuits
- High blocking voltage to 800 V

## 1.3 Applications

- Home appliances
- Low power AC fan speed controllers
- Low power motor control
- Low power loads in industrial process control

#### 1.4 Quick reference data

- $V_{DRM} \le 800 \text{ V}$
- $I_{TSM} \le 12.5 \text{ A (t = 20 ms)}$
- $I_{T(RMS)} \le 1 A$

- $I_{GT} \le 5 \text{ mA}$
- $I_{GT} \le 7 \text{ mA } (T2-G+)$

## **Pinning information**

Table 1. **Pinning** 

Pin	Description	Simplified outline	Graphic symbol
1	main terminal 2 (T2)		<b>N</b> 1
2	gate (G)		T2—T1
3	main terminal 1 (T1)	3 2 1 SOT54A	sym051



#### Four-quadrant triac, enhanced noise immunity

## 3. Ordering information

#### Table 2. Ordering information

Type number	Package					
	Name	Description	Version			
OT407	-	plastic single-ended leaded (through hole) package; 3 leads (wide pitch)	SOT54A			

## 4. Limiting values

#### Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DRM}$	repetitive peak off-state voltage		-	800	V
$V_{RRM}$	repetitive peak reverse voltage		-	800	V
I <sub>T(RMS)</sub>	RMS on-state current	full sine wave; $T_{lead} \le 38$ °C; see Figure 4 and 5	-	1	Α
I <sub>TSM</sub>	non-repetitive peak on-state current	full sine wave; $T_j = 25$ °C prior to surge; see Figure 2 and 3			
		t = 20 ms	-	12.5	Α
		t = 16.7 ms	-	13.8	Α
l <sup>2</sup> t	I <sup>2</sup> t for fusing	t <sub>p</sub> = 10 ms	-	1.28	A <sup>2</sup> s
dl <sub>T</sub> /dt	rate of rise of on-state current	$I_{TM} = 1 \text{ A}; I_G = 20 \text{ mA};$ $dI_G/dt = 0.2 \text{ A}/\mu\text{s}$			
		T2+ G+	-	50	A/μs
		T2+ G-	-	50	A/μs
		T2- G-	-	50	A/μs
		T2- G+	-	10	A/μs
I <sub>GM</sub>	peak gate current		-	1	Α
$P_{GM}$	peak gate power		-	2	W
P <sub>G(AV)</sub>	average gate power	over any 20 ms period	-	0.1	W
T <sub>stg</sub>	storage temperature		-40	+150	°C
T <sub>j</sub>	junction temperature		-	125	°C

#### Four-quadrant triac, enhanced noise immunity

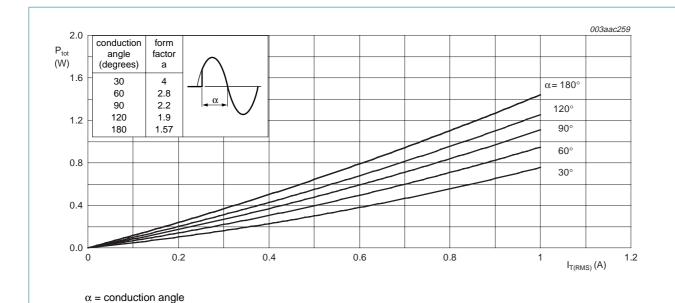


Fig 1. Total power dissipation as a function of RMS on-state current; maximum values

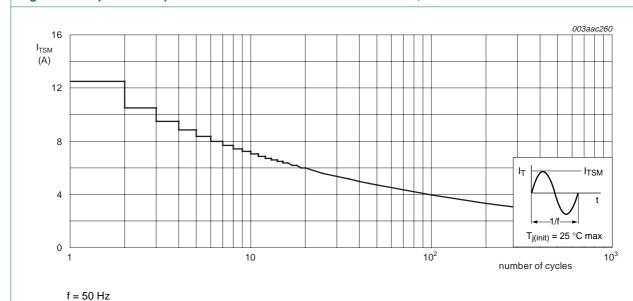
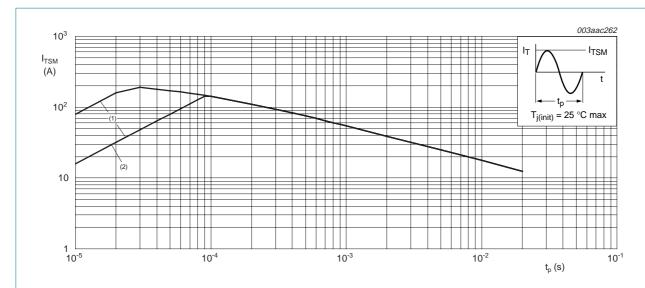


Fig 2. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

#### Four-quadrant triac, enhanced noise immunity



 $t_p \le 20 \text{ ms}$ 

- (1) dI<sub>T</sub>/dt limit
- (2) T2- G+ quadrant limit

Fig 3. Non-repetitive peak on-state current as a function of pulse width; maximum values

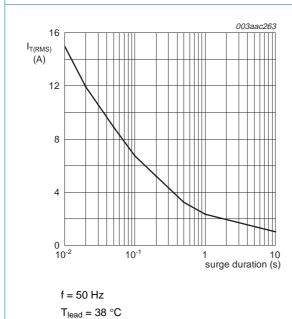


Fig 4. RMS on-state current as a function of surge duration; maximum values

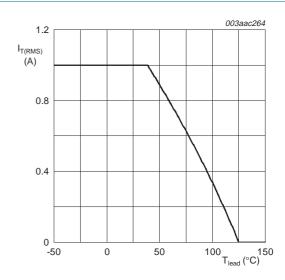


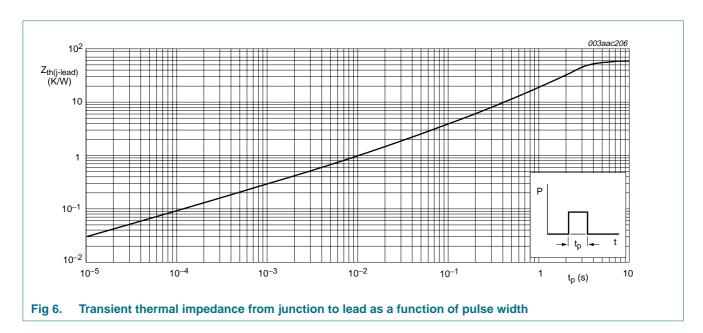
Fig 5. RMS on-state current as a function of solder point temperature; maximum values

#### Four-quadrant triac, enhanced noise immunity

## 5. Thermal characteristics

Table 4. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead	full cycle; see Figure 6	-	-	60	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient	full cycle; printed-circuit board mounted; lead length = 4 mm	-	150	-	K/W



#### Four-quadrant triac, enhanced noise immunity

## 6. Static characteristics

Table 5. Static characteristics

 $T_j = 25 \,^{\circ}C$  unless otherwise specified.

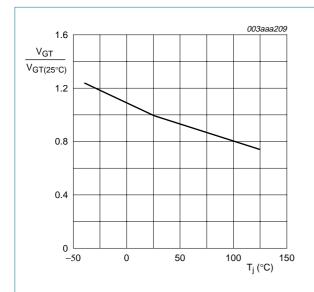
Parameter	Conditions	Min	Тур	Max	Unit
gate trigger current	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 8}}{}$				
	T2+ G+	0.25	-	5	mA
	T2+ G-	0.25	-	5	mA
	T2- G-	0.25	-	5	mA
	T2- G+	0.35	-	7	mA
I <sub>L</sub> latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{\text{Figure } 10}$				
	T2+ G+	-	-	10	mA
	T2+ G-	-	-	25	mA
	T2- G-	-	-	10	mA
	T2- G+	-	-	10	mA
holding current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{\text{Figure } 11}$	-	-	10	mA
on-state voltage	I <sub>T</sub> = 1 A; see <u>Figure 9</u>	-	1.3	1.6	V
gate trigger voltage	$V_D = 12 \text{ V; } I_T = 0.1 \text{ A; see } \frac{\text{Figure 7}}{}$	-	-	1.3	V
	$V_D = V_{DRM}; I_T = 0.1 A; T_j = 125 ^{\circ}C$	0.2	-	-	V
off-state current	$V_D = V_{DRM(max)}$ ; $T_j = 125  ^{\circ}C$	-	-	0.5	mA
	latching current  holding current on-state voltage gate trigger voltage	$ \begin{array}{lll} \text{gate trigger current} & V_D = 12 \ \text{V; } I_T = 0.1 \ \text{A; see } \underline{\text{Figure 8}} \\ & T2 + G + \\ & T2 + G - \\ & T2 - G - \\ & T2 - G + \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\ & \\$			$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$

#### Four-quadrant triac, enhanced noise immunity

## 7. Dynamic characteristics

Table 6. Dynamic characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV <sub>D</sub> /dt	rate of rise of off-state voltage	$V_{DM} = 0.67 V_{DRM(max)}$ ; $T_j = 110$ °C; exponential waveform; gate open circuit	20	-	-	V/μs
dV <sub>com</sub> /dt	rate of change of commutating voltage	$V_{DM} = 400 \text{ V}; T_j = 110 ^{\circ}\text{C}; I_{TM} = 1 \text{ A}; \\ dI_{com}/dt = 0.44 \text{ A/ms}$	1	-	-	V/μs



1 003aaa205

1GT (25°C)

3 (1)
(2)
(3)
(4)

1 -50 0 50 100 T<sub>j</sub> (°C)

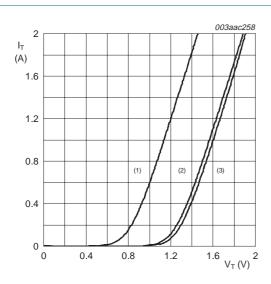
- (1) T2+ G+
- (2) T2+ G-
- (3) T2- G-
- (4) T2-G+

Fig 7. Normalized gate trigger voltage as a function of junction temperature

Fig 8. Normalized gate trigger current as a function of junction temperature

DT407\_1 © NXP B.V. 2008. All rights reserved.

#### Four-quadrant triac, enhanced noise immunity



 $V_0 = 1.254 \text{ V}; R_s = 0.31 \Omega$ 

- (1)  $T_i = 125 \,^{\circ}\text{C}$ ; typical values
- (2)  $T_j = 125 \,^{\circ}C$ ; maximum values
- (3)  $T_j = 25$  °C; maximum values

Fig 9. On-state current as a function of on-state voltage

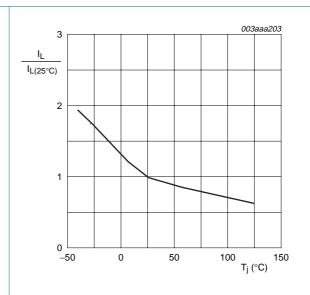


Fig 10. Normalized latching current as a function of junction temperature

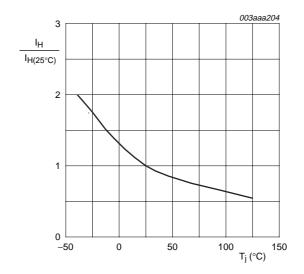


Fig 11. Normalized holding current as a function of junction temperature

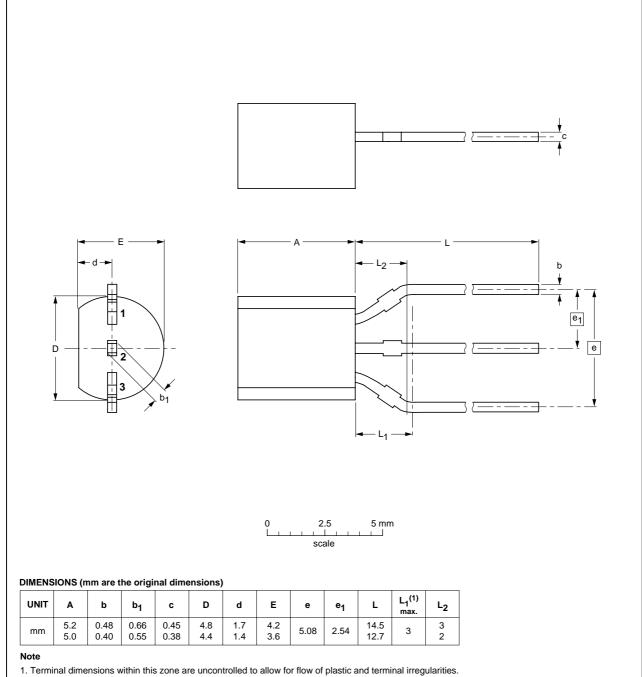
**OT407 NXP Semiconductors** 

#### Four-quadrant triac, enhanced noise immunity

## Package outline

## Plastic single-ended leaded (through hole) package; 3 leads (wide pitch)

SOT54A



OUTLINE	REFERENCES			EUROPEAN	ICCUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT54A						<del>97-05-13</del> 04-06-28	

Fig 12. Package outline SOT54A

© NXP B.V. 2008. All rights reserved.

## Four-quadrant triac, enhanced noise immunity

## 9. Revision history

#### Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
OT407_1	20080519	Product data sheet	-	-

#### Four-quadrant triac, enhanced noise immunity

## 10. Legal information

#### 10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

#### 10.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

#### 10.3 Disclaimers

**General** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental

damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <a href="http://www.nxp.com/profile/terms">http://www.nxp.com/profile/terms</a>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

**Quick reference data** — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

#### 10.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

#### 11. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

DT407\_1 © NXP B.V. 2008. All rights reserved.

#### Four-quadrant triac, enhanced noise immunity

#### 12. Contents

1	Product profile
1.1	General description
1.2	Features
1.3	Applications
1.4	Quick reference data
2	Pinning information
3	Ordering information
4	Limiting values 2
5	Thermal characteristics 5
6	Static characteristics 6
7	Dynamic characteristics
8	Package outline 9
9	Revision history
10	Legal information
10.1	Data sheet status
10.2	Definitions
10.3	Disclaimers
10.4	Trademarks 11
11	Contact information
12	Contents 12

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.



© NXP B.V. 2008.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 19 May 2008 Document identifier: OT407\_1